

IN THE U.S. PATENT AND TRADEMARK OFFICE

In re application of

Atsushi SAKURAI et al. Conf. 1454

Application No. 10/583,942 Group 1792

Filed June 22, 2006 Examiner Joel G. Horning

METAL COMPOUND, MATERIAL FOR THIN FILM FORMATION, AND PROCESS OF
FORMING THIN FILM

AMENDMENT

Assistant Commissioner for Patents October 13, 2009
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Official Action mailed May 12, 2009,
for which the period for response has been extended two months,
please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing
of claims which begins on page 2 of this paper.

Remarks begin on page 8 of this paper.